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Jameco Part Number 988451



September 1983 Revised January 2005

MM74HC74A Dual D-Type Flip-Flop with Preset and Clear

General Description

The MM74HC74A utilizes advanced silicon-gate CMOS technology to achieve operating speeds similar to the equivalent LS-TTL part. It possesses the high noise immunity and low power consumption of standard CMOS integrated circuits, along with the ability to drive 10 LS-TTL loads.

This flip-flop has independent data, preset, clear, and clock inputs and Q and \overline{Q} outputs. The logic level present at the data input is transferred to the output during the positive-going transition of the clock pulse. Preset and clear are independent of the clock and accomplished by a low level at the appropriate input.

The 74HC logic family is functionally and pinout compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

Features

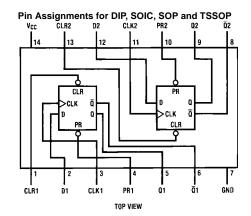
- Typical propagation delay: 20 ns
- Wide power supply range: 2-6V
- Low quiescent current: 40 µA maximum (74HC Series)
- Low input current: 1 µA maximum
- Fanout of 10 LS-TTL loads

Ordering Code:

Order Number	Package Number	Package Description
MM74HC74AM	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
MM74HC74AMX_NL	M14A	Pb-Free 14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
MM74HC74ASJ	M14D	Pb-Free 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HC74AMTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HC74AMTCX_NL	MTC14	Pb-Free 14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HC74AN	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code. Pb-Free package per JEDEC J-STD-020B.

Connection Diagram



Truth Table

Inputs				Outputs		
PR	CLR	CLK	D	Q	ρ	
L	Н	Χ	Х	Н	L	
Н	L	Χ	Χ	L	Н	
L	L	Χ	Χ	H (Note 1)	H (Note 1)	
Н	Н	\uparrow	Н	Н	L	
Н	Н	\uparrow	L	L	Н	
Н	Н	L	X	Q0	\overline{Q} 0	

Note: Q0 = the level of Q before the indicated input conditions were established.

Note 1: This configuration is nonstable; that is, it will not persist when preset and clear inputs return to their inactive (HIGH) level.

DATA PRESET CLOCK CLEAR

Absolute Maximum Ratings(Note 2)

(Note 3)

-0.5 to $+7.0$ V
-1.5 to $V_{CC} + 1.5V$
-0.5 to $V_{CC} + 0.5V$
±20 mA
±25 mA
±50 mA
-65°C to +150°C
600 mW
500 mW
260°C

Recommended Operating Conditions

	Min	Max	Units
Supply Voltage (V _{CC})	2	6	V
DC Input or Output Voltage	0	V_{CC}	V
(V _{IN} , _{OUT})			
Operating Temperature Range (T _A)	-40	+85	°C
Input Rise or Fall Times			
$(t_{\rm r}, t_{\rm f}) V_{\rm CC} = 2.0 V$		1000	ns
$V_{CC} = 4.5V$		500	ns
$V_{CC} = 6.0V$		400	ns
Note 2: Absolute Maximum Patings are those	n volues	hovend wh	ich dom

age to the device may occur.

Note 3: Unless otherwise specified all voltages are referenced to ground.

Note 4: Power Dissipation temperature derating — plastic "N" package: –
12 mW/°C from 65°C to 85°C.

DC Electrical Characteristics (Note 5)

Symbol	Parameter	Conditions	V _{CC}	T _A = 25°C		T _A = -40 to 85°C	T _A = -55 to 125°C	Units	
Зуппоп			*cc	Тур		Guaranteed Limits		Units	
V _{IH}	Minimum HIGH Level		2.0V		1.5	1.5	1.5	V	
	Input Voltage		4.5V		3.15	3.15	3.15	V	
			6.0V		4.2	4.2	4.2	V	
V _{IL}	Maximum LOW Level		2.0V		0.5	0.5	0.5	V	
	Input Voltage		4.5V		1.35	1.35	1.35	V	
			6.0V		1.8	1.8	1.8	V	
V _{OH}	Minimum HIGH Level	$V_{IN} = V_{IH}$ or V_{IL}							
	Output Voltage	$ I_{OUT} \leq 20 \; \mu A$	2.0V	2.0	1.9	1.9	1.9	V	
			4.5V	4.5	4.4	4.4	4.4	V	
			6.0V	6.0	5.9	5.9	5.9	V	
		$V_{IN} = V_{IH}$ or V_{IL}							
		$ I_{OUT} \le 4.0 \text{ mA}$	4.5V	4.3	3.98	3.84	3.7	V	
		$ I_{OUT} \le 5.2 \text{ mA}$	6.0V	5.2	5.48	5.34	5.2	V	
V _{OL}	Maximum LOW Level	$V_{IN} = V_{IH}$ or V_{IL}							
	Output Voltage	$ I_{OUT} \leq 20 \; \mu A$	2.0V	0	0.1	0.1	0.1	V	
			4.5V	0	0.1	0.1	0.1	V	
			6.0V	0	0.1	0.1	0.1	V	
		$V_{IN} = V_{IH}$ or V_{IL}							
		$ I_{OUT} \le 4.0 \text{ mA}$	4.5V	0.2	0.26	0.33	0.4	V	
		$ I_{OUT} \le 5.2 \text{ mA}$	6.0V	0.2	0.26	0.33	0.4	V	
I _{IN}	Maximum Input	$V_{IN} = V_{CC}$ or GND	6.0V		±0.1	±1.0	±1.0	μΑ	
	Current								
I _{CC}	Maximum Quiescent	V _{I N} =V _{CC} or GND	6.0V		4.0	40	80	μΑ	
	Supply Current	$I_{OUT} = 0 \mu A$							

Note 5: For a power supply of 5V \pm 10% the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5V and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

AC Electrical Characteristics

 $V_{CC} = 5V$, $T_A = 25^{\circ}C$, $C_L = 15$ pF, $t_r = t_f = 6$ ns

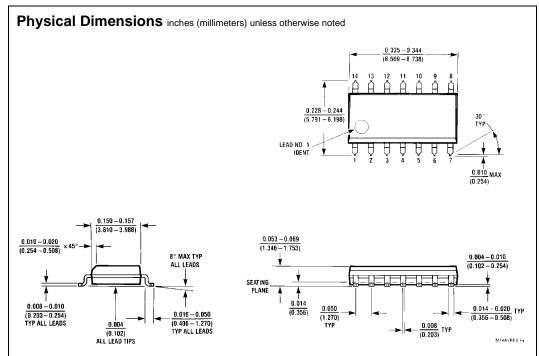
Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Units
f _{MAX}	Maximum Operating Frequency		72	30	MHz
t _{PHL} , t _{PLH}	Maximum Propagation Delay Clock to Q or Q		10	30	ns
t _{PHL} , t _{PLH}	Maximum Propagation Delay Preset or Clear to Q or Q		17	40	ns
t _{REM}	Minimum Removal Time, Preset or Clear to Clock		6	5	ns
t _s	Minimum Setup Time Data to Clock		10	20	ns
t _H	Minimum Hold Time Clock to Data		0	0	ns
t _W	Minimum Pulse Width Clock, Preset or Clear		8	16	ns

AC Electrical Characteristics

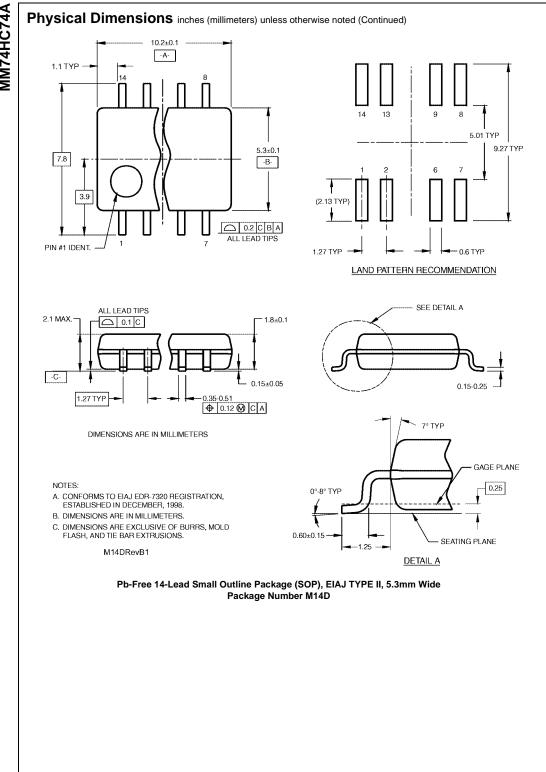
 $C_L = 50 \text{ pF}, t_r = t_f = 6 \text{ ns} \text{ (unless otherwise specified)}$

0	B	Conditions	v _{cc}	T _A = 25°C		T _A = -40 to 85°C T _A = -55 to 125°C		Unite
Symbol	Parameter			Тур		Guaranteed L	imits	Units
f _{MAX}	Maximum Operating		2.0V	22	6	5	4	MHz
	Frequency		4.5V	72	30	24	20	MHz
			6.0V	94	35	28	24	MHz
t _{PHL} , t _{PLH}	Maximum Propagation		2.0V	34	110	140	165	ns
	Delay Clock to Q or Q		4.5V	12	22	28	33	ns
			6.0V	10	19	24	28	ns
t _{PHL} , t _{PLH}	Maximum Propagation		2.0V	66	150	190	225	ns
	Delay Preset or Clear		4.5V	20	30	38	45	ns
	To Q or Q		6.0V	16	26	33	38	ns
t _{REM}	Minimum Removal Time		2.0V	20	50	65	75	ns
	Preset or Clear		4.5V	6	10	13	15	ns
	To Clock		6.0V	5	9	11	13	ns
t _s	Minimum Setup Time		2.0V	35	80	100	120	ns
	Data to Clock		4.5V	10	16	20	24	ns
			6.0V	8	14	17	20	ns
t _H	Minimum Hold Time		2.0V		0	0	0	ns
	Clock to Data		4.5V		0	0	0	ns
			6.0V		0	0	0	ns
t _W	Minimum, Pulse Width		2.0V	30	80	101	119	ns
	Clock, Preset or Clear		4.5V	9	16	20	24	ns
			6.0V	8	14	17	20	ns
t _{TLH} , t _{THL}	Maximum Output		2.0V	25	75	95	110	ns
	Rise and Fall Time		4.5V	7	15	19	22	ns
			6.0V	6	13	16	19	ns
t _r , t _f	Maximum Input Rise		2.0V		1000	1000	1000	ns
	and Fall Time		4.5V		500	500	500	ns
			6.0V		400	400	400	ns
C _{PD}	Power Dissipation	(per flip-flop)		80				pF
	Capacitance (Note 6)							
C _{IN}	Maximum Input			5	10	10	10	pF
	Capacitance							

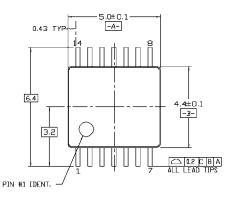
Note 6: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} \ V_{CC}^2 \ f + I_{CC} \ V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} \ V_{CC} \ f + I_{CC}$.

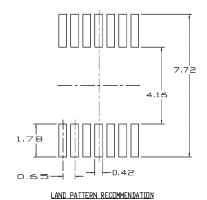


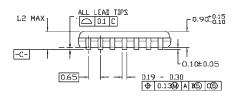
14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow Package Number M14A

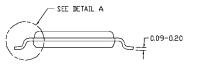


Physical Dimensions inches (millimeters) unless otherwise noted (Continued)





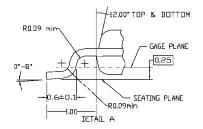




NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB, REF NOTE 6, DATED 7/93
- B. DIMENSIONS ARE IN MILLIMETERS
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
 D. DIMENSIONING AND TOLERANCES PER ANSI Y14-5M, BY

MTC14revD



14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC14

Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 0.740 - 0.770 (18.80 - 19.56)0.090 (2.286) 14 13 12 11 10 9 8 14 13 12 INDEX AREA 0.250 ± 0.010 (6.350 ± 0.254) PIN NO. 1 PIN NO. 1 IDENT 1 2 3 4 5 6 7 1 2 3 $\frac{0.092}{(2.337)}$ DIA 0.030 MAX (0.762) DEPTH OPTION 1 OPTION 02 $\frac{0.135 \pm 0.005}{(3.429 \pm 0.127)}$ 0.300 - 0.320 $\frac{0.630 - 8.128}{(7.620 - 8.128)}$ 0.060 0.145 - 0.2004° TYP Optional (1.651) (3.683 - 5.080) $\frac{0.008 - 0.016}{(0.203 - 0.406)}$ TYP 0.020 (0.508)0.125 - 0.150 0.075 ± 0.015 $\overline{(3.175 - 3.810)}$ (1.905 ± 0.381) (7.112) MIN 0.014 - 0.0230.100 ± 0.010 (2.540 ± 0.254) (0.356 - 0.584) $\frac{0.050 \pm 0.010}{(1.270 - 0.254)}$ TYP 0.325 ^{+0.040} -0.015

14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N14A

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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

8.255 + 1.016

N144 (REV.F)

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